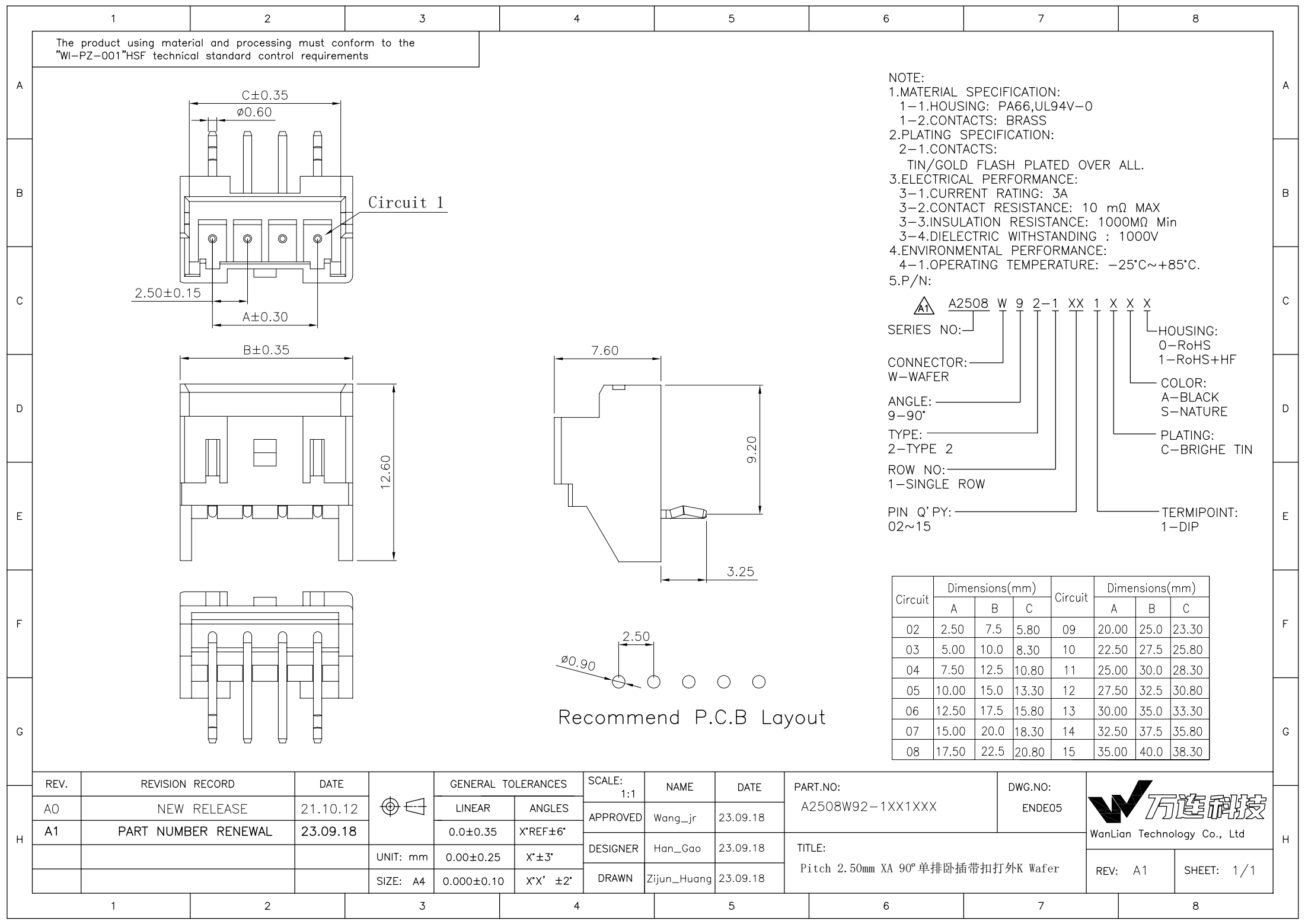




The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

- NOTE:
- 1.MATERIAL SPECIFICATION:
 - 1-1.HOUSING: PA66,UL94V-0
 - 1-2.CONTACTS: BRASS
 - 2.PLATING SPECIFICATION:
 - 2-1.CONTACTS:
 - TIN/GOLD FLASH PLATED OVER ALL.
 - 3.ELECTRICAL PERFORMANCE:
 - 3-1.CURRENT RATING: 3A
 - 3-2.CONTACT RESISTANCE: 10 mΩ MAX
 - 3-3.INSULATION RESISTANCE: 1000MΩ Min
 - 3-4.DIELECTRIC WITHSTANDING : 1000V
 - 4.ENVIRONMENTAL PERFORMANCE:
 - 4-1.OPERATING TEMPERATURE: -25°C~+85°C.
 - 5.P/N:

SERIES NO: A2508 W 9 2-1 XX 1 X X X

CONNECTOR: W-WAFER

ANGLE: 9-90°

TYPE: 2-TYPE 2

ROW NO: 1-SINGLE ROW

PIN Q' PY: 02~15

HOUSING: 0-RoHS 1-RoHS+HF

COLOR: A-BLACK S-NATURE

PLATING: C-BRIGHE TIN

TERMIPOINT: 1-DIP

Circuit	Dimensions(mm)			Circuit	Dimensions(mm)		
	A	B	C		A	B	C
02	2.50	7.5	5.80	09	20.00	25.0	23.30
03	5.00	10.0	8.30	10	22.50	27.5	25.80
04	7.50	12.5	10.80	11	25.00	30.0	28.30
05	10.00	15.0	13.30	12	27.50	32.5	30.80
06	12.50	17.5	15.80	13	30.00	35.0	33.30
07	15.00	20.0	18.30	14	32.50	37.5	35.80
08	17.50	22.5	20.80	15	35.00	40.0	38.30

Recommend P.C.B Layout

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: A2508W92-1XX1XXX	DWG.NO: ENDE05	 WanLian Technology Co., Ltd
A0	NEW RELEASE	21.10.12		LINEAR	ANGLES	APPROVED	Wang_jr	23.09.18			
A1	PART NUMBER RENEWAL	23.09.18		0.0±0.35	X°REF±6°						
			UNIT: mm	0.00±0.25	X°±3°	DESIGNER	Han_Gao	23.09.18	TITLE: Pitch 2.50mm XA 90° 单排卧插带扣打外K Wafer		
			SIZE: A4	0.000±0.10	X°X° ±2°	DRAWN	Zijun_Huang	23.09.18			
									REV: A1	SHEET: 1/1	